BU406, BU407

NPN Power Transistors

These devices are high voltage, high speed transistors for horizontal deflection output stages of TV's and CRT's.

Features

- High Voltage
- Fast Switching Speed
- Low Saturation Voltage
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector-Emitter Voltage	BU406 BU407	V _{CEO}	200 150	Vdc
Collector-Emitter Voltage	BU406 BU407	V _{CEV}	400 330	Vdc
Collector-Base Voltage	BU406 BU407	V _{CBO}	400 330	Vdc
Emitter-Base Voltage		V _{EBO}	6	Vdc
Collector Current – Continuous – Peak Repetitiv	Ι _C	7 10	Adc	
Collector Current – Peak (10 ms)	I _{CM}	15	Adc	
Base Current	Ι _Β	4	Adc	
Total Device Dissipation @ T _C = 25 Derate above 25°C	P _D	60 0.48	W ₩/°C	
Operating and Storage Junction Temperature Storage	T _J , T _{stg}	-65 to 150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.08	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	70	°C/W
Maximum Lead Temperature for Soldering Purposes1/8" from Case for 5 Seconds	ΤL	260	°C

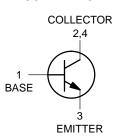


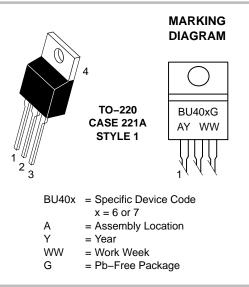
ON Semiconductor®

www.onsemi.com

NPN SILICON POWER TRANSISTORS 7 AMPERES – 60 WATTS 150 AND 200 VOLTS

SCHEMATIC





ORDERING INFORMATION

Device	Package	Shipping
BU406G	TO-220AB (Pb-Free)	50 Units / Rail
BU407G	TO–220AB (Pb–Free)	50 Units / Rail

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

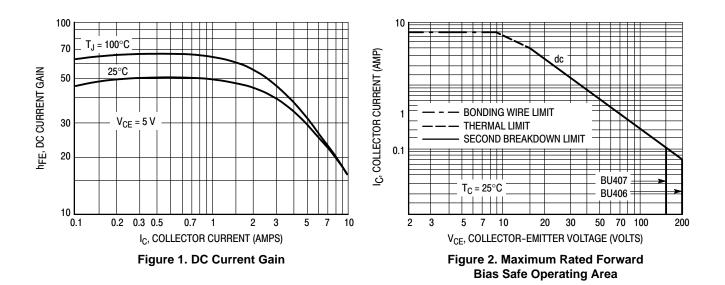
BU406, BU407

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS				•		
Collector–Emitter Sustaining Voltage (Note 1) $(I_{C} = 100 \text{ mAdc}, I_{B} = 0)$	BU406 BU407	V _{CEO(sus)}	200 150	_ _		Vdc
		I _{CES}	- - -	- - -	5 0.1 1	mAdc
Emitter Cutoff Current ($V_{EB} = 6 \text{ Vdc}, I_C = 0$)	BU406, BU407	I _{EBO}	-	-	1	mAdc
ON CHARACTERISTICS (Note 1)						
Collector–Emitter Saturation Voltage $(I_C = 5 \text{ Adc}, I_B = 0.5 \text{ Adc})$		V _{CE(sat)}	-	-	1	Vdc
Base–Emitter Saturation Voltage ($I_C = 5 \text{ Adc}, I_B = 0.5 \text{ Adc}$)		V _{BE(sat)}	-	-	1.2	Vdc
Forward Diode Voltage (I _{EC} = 5 Adc) "D" only	V_{EC}	-	-	2	Volts	
DYNAMIC CHARACTERISTICS						
Current–Gain – Bandwidth Product ($I_C = 0.5 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 20 \text{ MHz}$)	f _T	10	-	-	MHz	
Output Capacitance $(V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1 \text{ MHz})$	C _{ob}	-	80	-	pF	
SWITCHING CHARACTERISTICS			•	·	•	
Inductive Load Crossover Time (V _{CC} = 40 Vdc, I _C = 5 Adc, I _{B1} = I _{B2} = 0.5 Adc,	t _c	-	-	0.75	μs	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

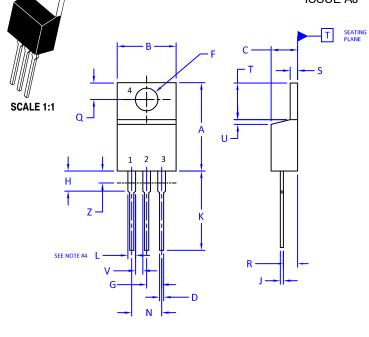
1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 1%.



DATE 05 NOV 2019



TO-220 CASE 221A-09 ISSUE AJ



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 2009.

2. CONTROLLING DIMENSION: INCHES

3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

4. MAX WIDTH FOR F102 DEVICE = 1.35MM

	INCHES		MILLIMETERS	
DIM	MIN.	MAX.	MIN.	MAX.
А	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.60	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
К	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.41
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

STYLE 1: PIN 1. 2. 3. 4.	COLLECTOR EMITTER	STYLE 2: PIN 1. 2. 3. 4.	EMITTER	3.	CATHODE ANODE GATE ANODE	STYLE 4: PIN 1. 2. 3. 4.	MAIN TERMINAL 1 MAIN TERMINAL 2 GATE MAIN TERMINAL 2
STYLE 5: PIN 1. 2. 3. 4.	DRAIN SOURCE	2. 3.	ANODE CATHODE ANODE CATHODE	2. 3.	CATHODE ANODE CATHODE ANODE	STYLE 8: PIN 1. 2. 3. 4.	
STYLE 9: PIN 1. 2. 3. 4.	COLLECTOR EMITTER	STYLE 10: PIN 1. 2. 3. 4.	GATE SOURCE DRAIN	STYLE 11: PIN 1. 2. 3. 4.	DRAIN SOURCE GATE	STYLE 12 PIN 1. 2. 3. 4.	MAIN TERMINAL 1 MAIN TERMINAL 2 GATE NOT CONNECTED

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